IGBT modules: T series LV100 type reliability test results

Table 1. Reliability test results

The results for representative module are shown in below table.

Test Category 試験項目	Test condition 試験条件		Number of samples 試料数	Number of failures 故障数
Temperature cycling 温度サイクル	-40 °C ~ 125 °C (air), 10 cycles t=60 minutes at each temp.		5	0
Variable frequency vibration 振動	10Hz - 500Hz / 15 min., 100m/s ² =10G, X, Y, Z: 2 hours in each direction.		5	0
Tightening strength 締付トルク強度	Main terminals: 14.0N·m(M8) Auxiliary terminals: 0.6N·m(M3) Mounting to heat sink: 4.5N·m(M6)		5	0
High temperature Storage 高温保存	Ta=125 °C t=1000 hours		5	0
Low temperature Storage 低温保存	Ta=-40 °C t=1000 hours		5	0
Moisture resistance 耐湿性	Ta=60 °C, 90 %RH t=1000 hours		5	0
High temperature reverse bias 高温逆バイアス	Tvj=150 °C, Vce(DC)=Vces(rating) x 0.85, VGE=short, t=1000 hours		5	0
High temperature gate bias 高温ゲートバイアス	Tvj=150 °C,	V _{GE} (DC)=+20V	5	0
	VCE=short, t=1000 hours	VGE(DC)=-20V	5	0
Intermittent operation life 断続通電	Tc=50~100 °C, 5,000 cycles		5	0

Table 2. Failure criteria

Parameter 测点项目	Measurement conditions 測定条件	Criteria for failure 故障判定基準	
測定項目		Lower/下限	Upper/上限
ICES	VCE=VCES(rating), G-E short-circuited	_	U.S.L.×2.0
IGES	VGE=VGES(rating), C-E short-circuited	_	U.S.L.×2.0
VGE(th)	IC=IC(rating)/10000A, VCE=10V	L.S.L.×0.8	U.S.L.×1.2
VCEsat	IC=IC(rating)A, VGE=15V	_	U.S.L.×1.2
VEC	IE=IE(rating)A, G-E short-circuited	_	U.S.L.×1.2
Visol	V _{isol} = V _{isol} (rating), AC 1 minute between shorted all terminals and base plate	Break down	

Additional notes:

- (1) The measurements are performed under our determined temperature and humidity environment.
- (2) The symbols in the table are as follows.
 - U.S.L: Upper Specification Limit
 - L.S.L: Lower Specification Limit
- (3) The U.S.Ls and L.S.Ls are determined on the basis of Specification, which is designated as our standard module specification. In regards to those not defined in Specification, our own internal specifications are applied in lieu thereof.
- (4) The measurement items of each test are selected according to our standards

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